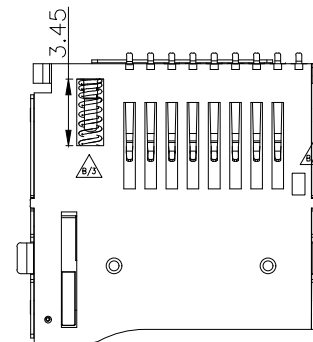
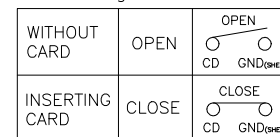
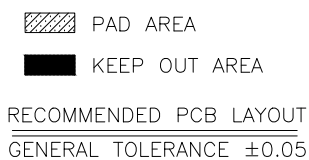
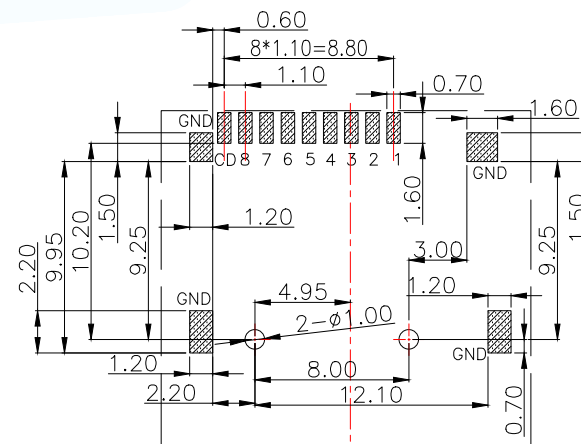
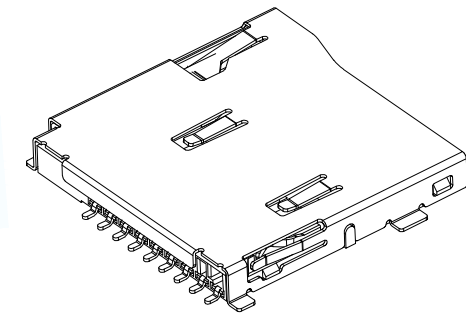


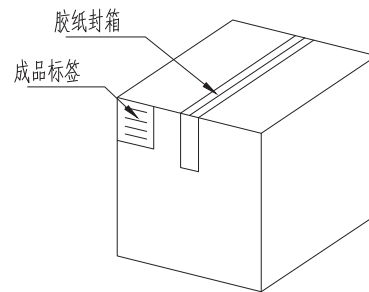
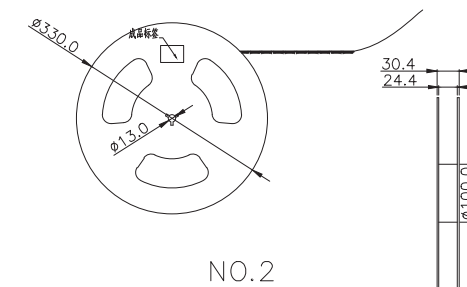
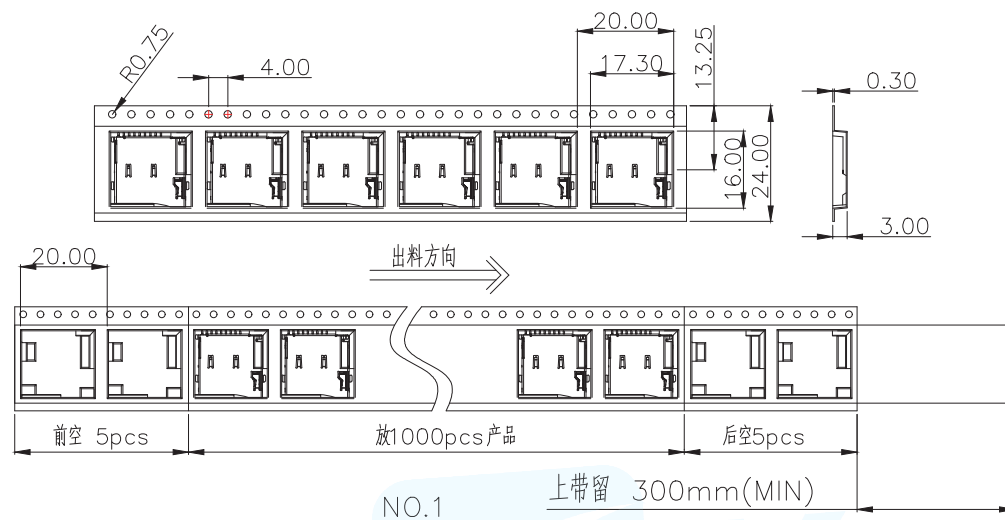


1. Electrical Characteristics:
 - Contact Current Rating: 0.5 Amperes.
 - Dielectric Withstanding Voltage: AC500V r.m.s.
 - Insulation Resistance: 1000 MΩ Minimum.
 - Contact Resistance: 40 mΩ Maximum.
2. Environmental:
 - Operating Temperature: -25°C ~ +90°C.
3. Environmental:
 - Mating Cycles: 5,000 Insertions.
4. Mechanical Characteristics:
 - Card Push Insertion/Out Force: 0.2 ~ 1.40 kgf.
 - Contact Separation Force: 0.20 kgf Minimum.
5. Material:
 - Insulator: HI-Temp Plastic UL 94V-0 Rated.
 - Contact: Copper Alloy (t=0.15mm).
 - Shell: Stainless Steel (t=0.15mm).
 - Spring: SWP.
 - Salt spray time: 24H



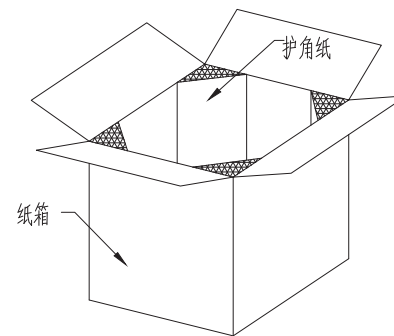
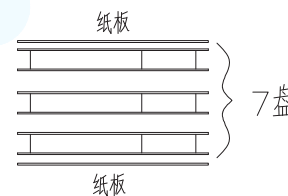
TF CARD PIN DEFINE			
PIN NO.	NAME	TYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BITO)
8	DAT1	I/O/PP	DATE LINE(DIT1)

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:MICRO SD CARD PUSH PUSH SMT 镀金 双压片 外焊		
			PAR	TF-115K-ACP9	
DECIMALS:	ANGLES:		DWN		
X.X:±0.35	X.X":±3°		CHKD		
X.XX:±0.25	X.XX":±2°	APVD			
X.XXX:±0.15		SCALE:1:1	UNIT:MM 		
		CUSTOMER COPY	SIZE:A4	SHEET:1F1	REV:A



纸箱规格:340*340*322

NO.4



NO.3

1. 材质要求:

- 1.1 纸箱的材质为K=K;外形尺寸为34*34*32.2;
- 1.2 卷盘的材质为PS,卷盘的外形尺寸为φ330*30.4;

2. 包装方式:

- 2.1 将卷带放入包装机后,前空5PCS,后放产品1000PCS,再后空5PCS;上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好,贴上内盘标签;
- 2.3 把累叠好的7盘叠放入纸箱中共计7Kset,上下放纸板;
- 2.4 把包装好的成品打包封箱,并在纸箱外贴上标签

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:MICRO SD CARD PUSH PUSH SMT 双压片 外焊 包装图	
			PAR	TF-115K-ACP9
DECIMALS:	ANGLES:		DWN	
X.X:±0.35	X.X':±3°		CHKD	
X.XX:±0.25	X.XX':±2°		APVD	
X.XXX:±0.15		CUSTOMER COPY	SCALE:1:1	UNIT:MM
			SIZE:A4	SHEET:2F2
				REV:A